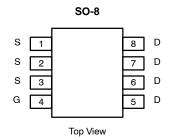


# P-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	$r_{DS(on)}\left(\Omega\right)$	I <sub>D</sub> (A)		
-30	0.042 @ V <sub>GS</sub> = -10 V	-5.7		
	0.055 @ V <sub>GS</sub> = -6 V	-5.0		
	0.070 @ V <sub>GS</sub> = -4.5 V	-4.4		

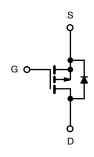
#### **FEATURES**

• TrenchFET® Power MOSFET



Ordering Information: Si9435BDY

Si9435BDY-T1 (with Tape and Reel)
Si9435BDY—E3 (Lead (Pb)-Free)
Si9435BDY-T1—E3 (Lead (Pb)-Free with Tape and Reel)



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^{\circ}C$ UNLESS OTHERWISE NOTED)						
Parameter		Symbol	10 secs	Steady State	Unit	
Drain-Source Voltage		V <sub>DS</sub>	-30		V	
Gate-Source Voltage		V <sub>GS</sub>	±20			
Continuous Drain Current (T <sub>.1</sub> = 150°C) <sup>a</sup>	T <sub>A</sub> = 25°C	. I <sub>D</sub>	-5.7	-4.1		
Commission Surrent (1) = 130 O)	T <sub>A</sub> = 70°C		-4.6	-3.2	A	
Pulsed Drain Current		I <sub>DM</sub>	-30			
continuous Source Current (Diode Conduction) <sup>a</sup>		I <sub>S</sub>	-2.3	-1.1		
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 25°C	P <sub>D</sub>	2.5	1.3	W	
	T <sub>A</sub> = 70°C		1.6	0.8	VV	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	–55 to 150		°C	

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
	t ≤ 10 sec	R <sub>thJA</sub>	40	50			
Maximum Junction-to-Ambient <sup>a</sup>	Steady State		70	95	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	24	30			

#### Notes

a. Surface Mounted on 1" x 1" FR4 Board.

## **Si9435BDY**

# Vishay Siliconix



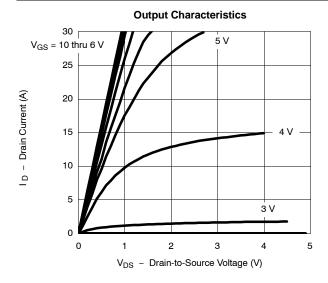
SPECIFICATIONS ( $T_J = 25^{\circ}C$ UNLESS OTHERWISE NOTED)								
Parameter	Symbol	Test Condition	Min	Typ <sup>a</sup>	Max	Unit		
Static			•		•			
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = -250 \mu A$	-1.0		-3.0	V		
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS}$ = 0 V, $V_{GS}$ = $\pm 20$ V			±100	nA		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}$			-1	μΑ		
		$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 70^{\circ}\text{C}$			-5			
On-State Drain Current <sup>b</sup>	I <sub>D(on)</sub>	$V_{DS} \leq -10 \text{ V}, V_{GS} = -10 \text{ V}$	-20			Α		
		$V_{DS} \le -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	-5					
	r <sub>DS(on)</sub>	$V_{GS} = -10 \text{ V}, I_D = -5.7 \text{ A}$		0.033	0.042	Ω		
Drain-Source On-State Resistance <sup>b</sup>		V <sub>GS</sub> = -6 V, I <sub>D</sub> = -5 A		0.043	0.055			
		$V_{GS} = -4.5 \text{ V}, I_D = -4.4 \text{ A}$		0.056	0.070			
Forward Transconductanceb	9 <sub>fs</sub>	$V_{DS} = -15 \text{ V}, I_D = -5.7 \text{ A}$		13		S		
Diode Forward Voltage <sup>b</sup>	V <sub>SD</sub>	$I_S$ = -2.3 A, $V_{GS}$ = 0 V		-0.8	-1.1	V		
Dynamic <sup>a</sup>								
Total Gate Charge	Qg			16	24	nC		
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = -15 \text{ V}, \ V_{GS} = -10 \text{ V}, \ I_D = -3.5 \text{ A}$		2.3				
Gate-Drain Charge	Q <sub>gd</sub>			4.5				
Gate Resistance	R <sub>g</sub>			8.8		Ω		
Turn-On Delay Time	t <sub>d(on)</sub>			14	25			
Rise Time	t <sub>r</sub>	$V_{DD}$ = -15 V, $R_L$ = 15 $\Omega$		14	25	ns		
Turn-Off Delay Time	t <sub>d(off)</sub>	$\begin{aligned} V_{DD} &= -15 \text{ V}, \text{ R}_L = 15 \Omega \\ I_D &\cong -1 \text{ A}, \text{ V}_{GEN} = -10 \text{ V}, \text{ R}_g = 6 \Omega \end{aligned}$		42	70			
Fall Time	t <sub>f</sub>			30	50			
Source-Drain Reverse Recovery Time	t <sub>rr</sub>	$I_F = -1.2 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$		30	60	1		

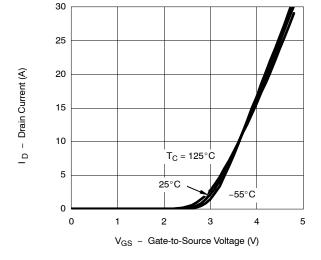
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

a. Guaranteed by design, not subject to production testing. b. Pulse test; pulse width  $\leq 300~\mu s$ , duty cycle  $\leq 2\%$ .

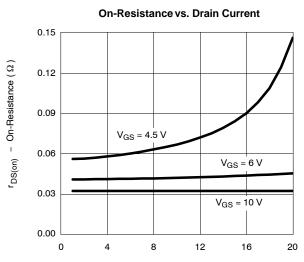


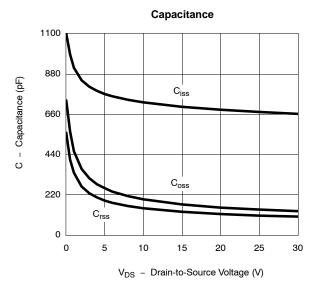
#### TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)

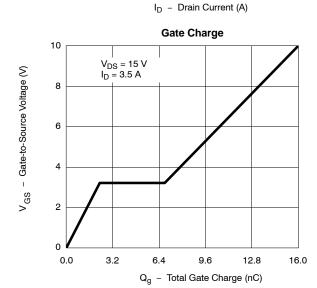


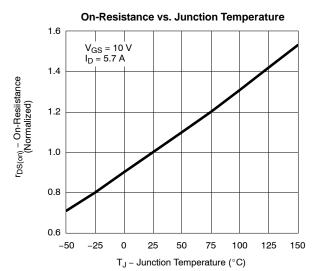


**Transfer Characteristics** 



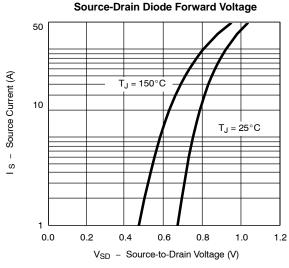


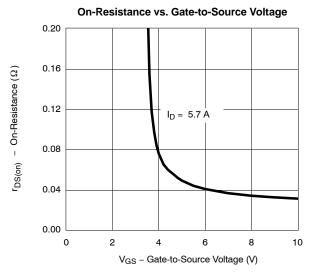


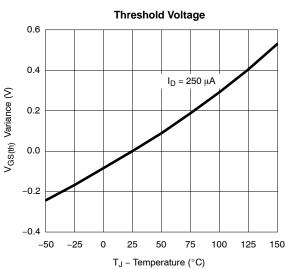


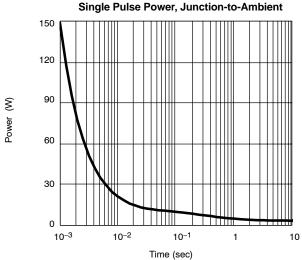


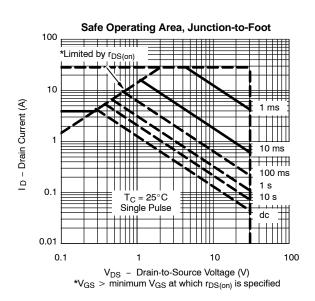
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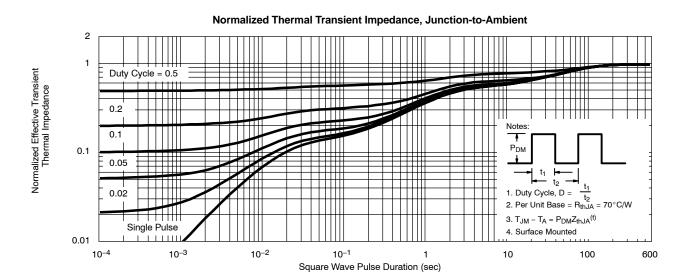


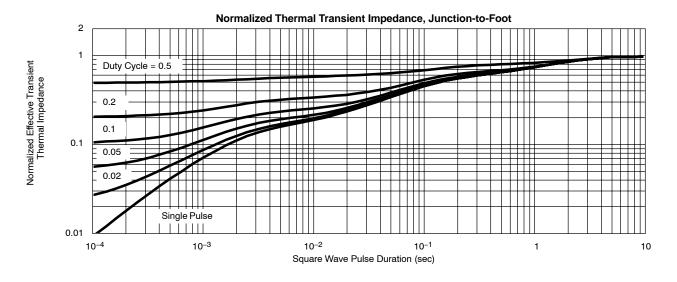






#### TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)





Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?72245">http://www.vishay.com/ppg?72245</a>.



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